

# NCE10TD60BF

# 600V, 10A, Trench FS II Fast IGBT

#### **General Description:**

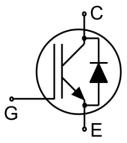
Using NCE's proprietary trench design and advanced FS (Field Stop) second generation technology, the 600V Trench FSII IGBT offers superior conduction and switching performances, and easy parallel operation;

#### **Features**

- Trench FSII Technology Offering
- Very low V<sub>CE(sat)</sub>
- High speed switching
- Positive temperature coefficient in V<sub>CE(sat)</sub>
- Very tight parameter distribution
- High ruggedness, temperature stable behavior

# **Application**

- Air Condition
- Inverters
- Motor drives



Schematic diagram

## **Package Marking and Ordering Information**

Device	Device Package	Device Marking		
NCE10TD60BF	TO-220F	NCE10TD60BF		



TO-220F

# **Absolute Maximum Ratings (Tc=25°C unless otherwise noted)**

Symbol	Parameter	Value	Units
Vces	Collector-Emitter Voltage	600	V
V <sub>GES</sub>	Gate- Emitter Voltage	±30	V
1.	Collector Current	20	А
lc	Collector Current @T <sub>C</sub> = 100 °C	10	A
I <sub>Cplus</sub>	Pulsed Collector Current, t <sub>p</sub> limited by T <sub>jmax</sub>	30	A
-	turn off safe operating area, V <sub>CE</sub> =600V, Tj=150°C	30	A
l <sub>F</sub>	Diode Continuous Forward Current @T <sub>C</sub> = 100 °C	10	А
I <sub>FM</sub>	Diode Maximum Forward Current	30	A
D-	Power Dissipation @ T <sub>C</sub> = 25°C	33	W
P <sub>D</sub>	Power Dissipation @T <sub>C</sub> = 100°C	16.5	W
$T_J, T_{stg}$	Operating Junction and Storage Temperature Range	-55 to +175	°C
TL	Maximum Temperature for Soldering	260	°C
t <sub>sc</sub>	Short circuit withstand time V <sub>GE</sub> =15 V, V <sub>CC</sub> ≤400V, Allowed number of short circuits<1000Time between short circuits:≥1.0s,T <sub>j</sub> ≤150°C	5	us



## **Thermal Characteristic**

Symbol Parameter		Value	Units
Rejc	Thermal Resistance, Junction to case for IGBT	4.54	°C/W
Rejc	Thermal Resistance, Junction to case for Diode	4.04	°C/W
R <sub>0JA</sub>	Thermal Resistance, Junction to Ambient	78	°C/W

# Electrical Characteristics (Tc=25°C unless otherwise noted)

0	Barrantan	Test Conditions		Value			
Symbol	Parameter			Min.	Тур.	Max.	Units
Static Chara	cteristics						
V <sub>(BR)CES</sub>	Collector-Emitter Breakdown Voltage	V <sub>GE</sub> =0V	,I <sub>CE</sub> =1mA	600			V
Ices	Collector-Emitter Leakage Current	V <sub>GE</sub> =0V	Vce=600V			4	uA
I <sub>GES(F)</sub>	Gate to Emitter Forward Leakage	V <sub>GE</sub> =+30	V,Vce=0V			100	nA
I <sub>GES(R)</sub>	Gate to Source Reverse Leakage	V <sub>GE</sub> =-30	V,Vce =0V			100	nA
V <sub>CE(sat)</sub>	Collector-Emitter Saturation Voltage	Ic=10A	Tj=25°C		1.7	1.9	V
(****)	Ţ.	V <sub>GE</sub> =15V	Tj=100°C		1.9		V
$V_{GE(th)}$	Gate Threshold Voltage	Ic=1mA,VcE=VgE		4.0	5.0	6.0	V
Dynamic Cha	aracteristics						
Cies	Input Capacitance	V <sub>CE</sub> =25V,V <sub>GE</sub> =0V, f=1MHz			1127		pF
Coes	Output Capacitance				40		
$C_{res}$	Reverse Transfer Capacitance				24		
$Q_g$	Total Gate Charge	Vcc=480V, Ic=10A V <sub>GE</sub> =15V			44		nC
Qge	Gate to Emitter Charge				10		
Qgc	Gate to Collector Charge				19		
I <sub>C(SC)</sub>	Short circuit collector current Max.1000 short circuits Time between short circuits: ≥1.0s	V <sub>GE</sub> =15V,V <sub>CC</sub> ≤400V, t <sub>SC</sub> ≤5us,Tj≤150°C		1	50		А
Switching Cl	haracteristics						
$t_{\text{d(ON)}}$	Turn-on Delay Time				20		
t <sub>r</sub>	Rise Time	Vcc=400V,Ic=10A			15		ns
$t_{\text{d(OFF)}}$	Turn-Off Delay Time				73		
t <sub>f</sub>	Fall Time	$V_{GE}=0/15V$ , $R_g=5\Omega$			18		
Eon	Turn-On Switching Loss	Inductive Load			0.21		
E <sub>off</sub>	Turn-Off Switching Loss				0.11		mJ
Ets	Total Switching Loss	]			0.32		

# Electrical Characteristics of the Diode(Tc= 25°C unless otherwise specified):

Symbol	Parameter	Toot Conditions	Rating			Units
	Parameter	Test Conditions	Min.	Тур.	Max.	Units
$V_{FM}$	Diode Forward Voltage	I <sub>F</sub> =10A		1.5	1.7	٧
Trr	Reverse Recovery Time			158		ns
I <sub>RRM</sub>	Diode Peak Reverse Recovery Current	I <sub>F</sub> =10A, di/dt=200A/us		5.8		А
Qrr	Reverse Recovery Charge			0.5		uC
Pulse width $t_{tp} \le 380 \mu s, \delta \le 2\%$						

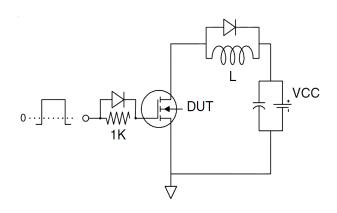
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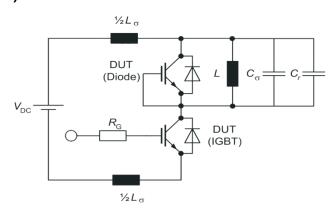
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#### **Test Circuit**

## 1) Gate Charge Test Circuit

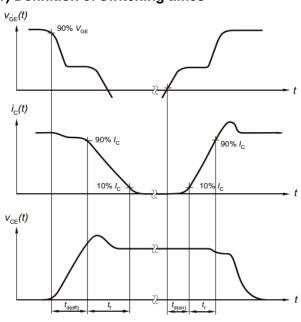


#### 2) Switch Time Test Circuit

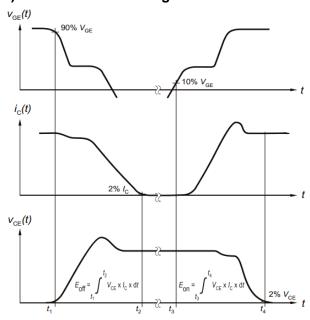


# **Switching characteristics**

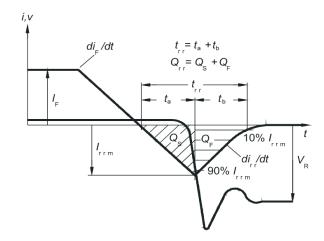
## 1) Definition of switching times



#### 2) Definition of switching losses



## 3) Definition of diode switching characteristics





# **Typical Electrical and Thermal Characteristics**

**Figure 1 Output Characteristics** 

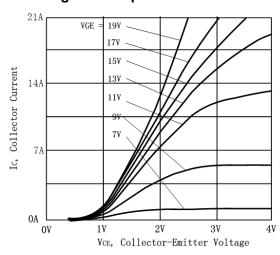
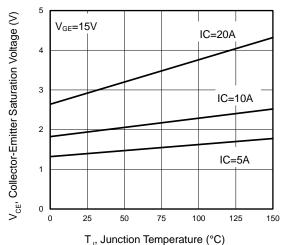
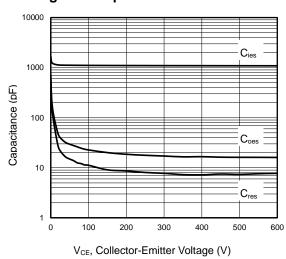


Figure 3 V<sub>CEsat</sub> vs. Case Temperature



**Figure 5 Capacitance Characteristics** 



**Figure 2 Transfer Characteristics** 

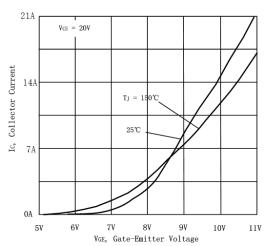


Figure 4 Saturation Voltage vs. VGE

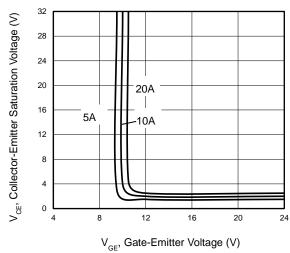
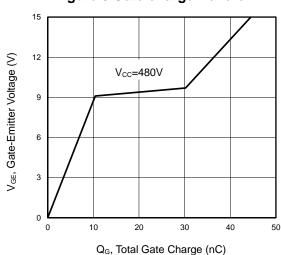


Figure 6 Gate charge waveform



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## **Typical Electrical and Thermal Characteristics**

#### **Figure 7 Forward Characteristics**

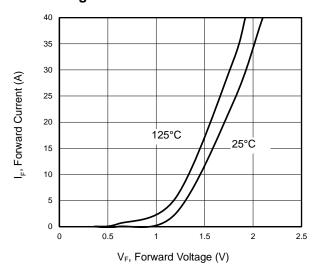


Figure 9 Typical Switching Times as a **Function of Gate Resistor** 

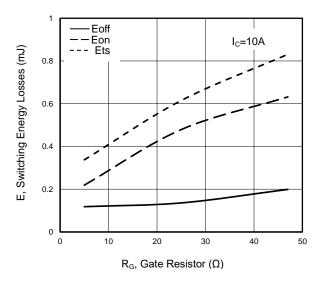


Figure 11 Gate-emitter Threshold Voltage as a **Function of Junction Temperature** 

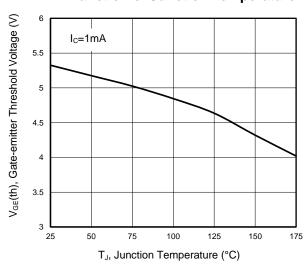


Figure 8 V<sub>F</sub> vs. temperature

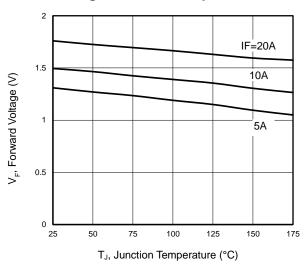
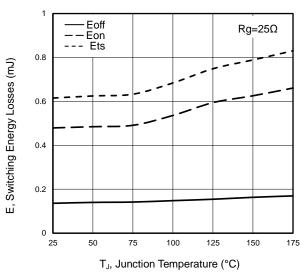
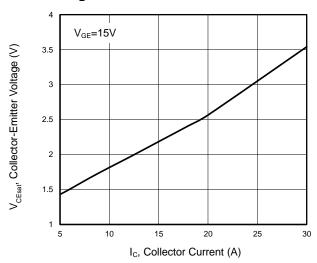


Figure 10 Typical Switching Times as a **Function of Junction Temperature** 



**Figure 12 Typical Collector-emitter Saturation** Voltage as a function of Collector Current

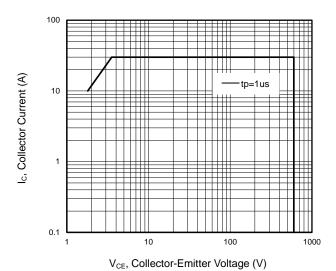


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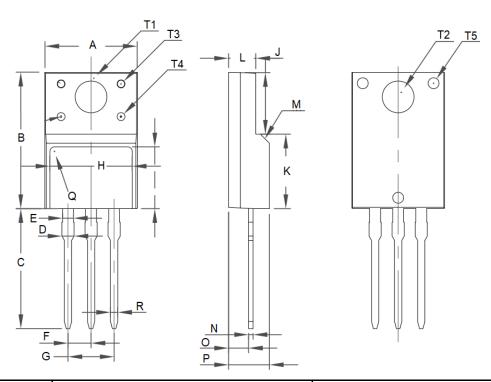
# **Typical Electrical and Thermal Characteristics**

# Figure 13 Forward Bias Safe Operating Area





# **TO-220F Package Information**



Symbol	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
Α	9.96	10.36	0.39	0.41	
В	15.67	16.07	0.62	0.63	
С	13.14	13.54	0.52	0.53	
D	1.20	1.40	0.05	0.06	
E	1.20	BSC	0.05	BSC	
F	2.54	BSC	0.10	BSC	
G	5.08	BSC	0.20	BSC	
Н	7.60	8.00	0.30	0.31	
I	7.10	7.50	0.28	0.30	
J	6.48	6.88	0.26	0.27	
K	8.99	9.39	0.35	0.37	
L	2.34	2.74	0.09	0.11	
М	45	0	1.77	BSC	
N	0.49	0.52	0.02	0.02	
0	2.15	2.55	0.08	0.10	
Р	4.50	4.90	0.18	0.19	
Q	0.	50	0.02	BSC	
R	0.77	0.83	0.03	0.03	
S	4°	5°	0.16	0.20	
T1	3.45 BSC		0.14 BSC		
T2	3.18 BSC		0.13 BSC		
Т3	1.50 BSC		0.06 BSC		
T4	1.20	BSC	0.05 BSC		
T5	1.50	BSC	0.06 BSC		

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